

Si PIN photodiode

S7478

Large photosensitive area (5 \times 5 mm) photosensor with high reliability

The S7478 is a PIN photodiode having a large photosensitive area (5×5 mm) and surface mount flat package with leads.

Features

- Surface mount plastic package: 9 × 9.6 × 1.5^t mm
- Large photosensitive area: 5 × 5 mm
- Operating temperature range: -25 to +85 °C Storage temperature range: -40 to +100 °C
- High sensitivity: 0.72 A/W (λ=960 nm)

Applications

- Automobile sensor (Vehicle and traffic information system, laser radar, front window frost sensor, rain sensor)
- **FSO (free space optics)**

Structure

Parameter	Specification	Unit
Photosensitive area	5 × 5	mm
Package	Plastic	-
Window material	Silicone resin	-

- Absolute maximum ratings

Parameter	Symbol	Condition	Specification	Unit
Reverse voltage	VR max.	Ta=25 °C	20	V
Operating temperature	Topr		-25 to +85	°C
Storage temperature	Tstg		-40 to +100	°C
Reflow soldering conditions	Tsol*1		Peak temperature 240 °C max., two times (see page 4)	-

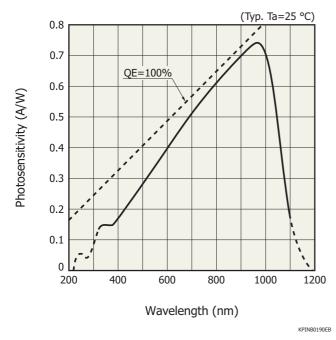
Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

*1: JEDEC level 5a

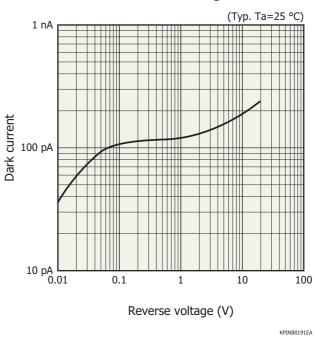
Electrical and optical characteristics (Ta=25 °C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Spectral response range	λ		-	320 to 1100	-	nm
Peak sensitivity wavelength	λр		-	960	-	nm
Photosensitivity	S	λ=λp	0.6	0.72	-	A/W
Short circuit current	Isc	100 <i>lx</i> , 2856 K	-	26	-	μA
Dark current	ID	VR=10 V	-	0.4	5	nA
Temperature coefficient of ID	TCID		-	1.14	-	times/°C
Cutoff frequency	fc	V _R =10 V, R _L =50 Ω -3 dB, λ=780 nm	10	20	-	MHz
Terminal capacitance	Ct	VR=10 V, f=1 MHz	-	40	60	pF

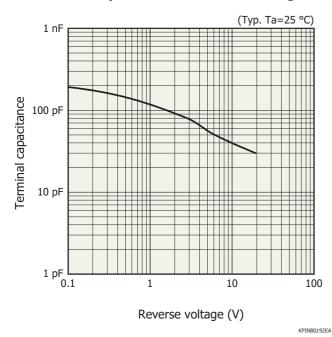
Spectral response



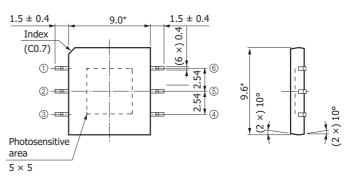
Dark current vs. reverse voltage

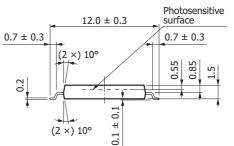


Ferminal capacitance vs. reverse voltage



Dimensional outline (unit: mm)





Anode
Cathode

⑤ Cathode⑥ NC

③ NC

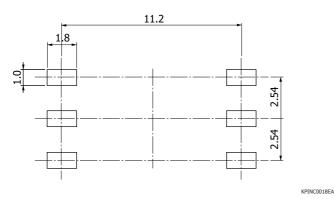
(4) NC

Tolerance unless otherwise noted: ± 0.1 Chip position accuracy with respect to the package dimensions marked *: X, Y $\leq \pm 0.2$, $\theta \leq \pm 2^{\circ}$

KPINA0062EA



Recommended land pattern (unit: mm)

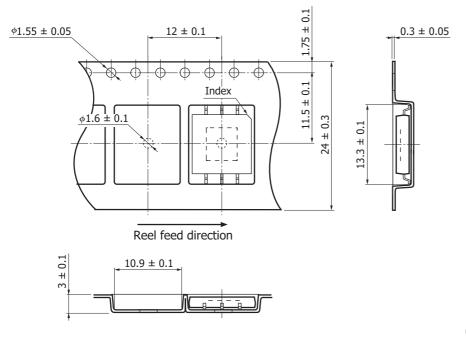


Standard packing specifications

Reel (conforms to JEITA ET-7200)

Dimensions	Tape width	Material	Electrostatic characteristics
254 mm	24 mm	PS	Conductive

Enbossed tape (unit: mm, material: PS, conductive)

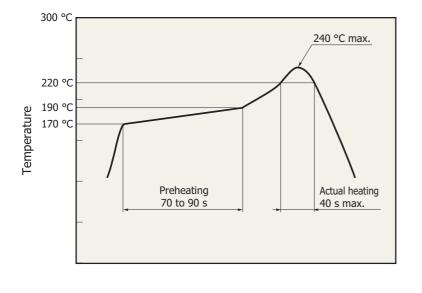


KPINC0025EA

- Packing quantity 1000 pcs/reel
- Packing type

Reel and desiccant in moisture-proof packaging (vacuum-sealed)





Measured example of temperature profile with hot-air reflow oven for product testing

Time

KPICB0164EC

- This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 24 hours.
- . The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. Before actual reflow soldering, check for any problems by testing out the reflow soldering methods in advance.

Related information

- Precautions
- · Disclaimer
- · Metal, ceramic, Plastic Package products
- Surface mount type products

Information described in this material is current as of July 2016.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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